

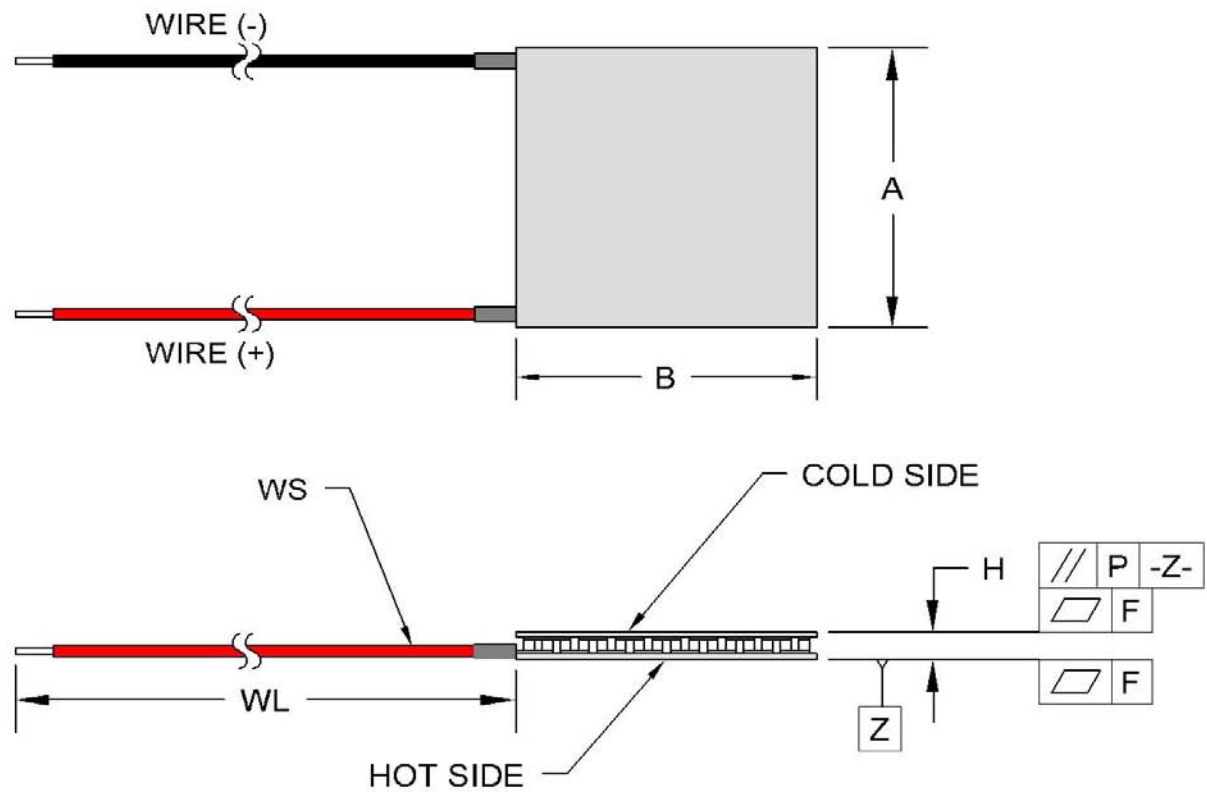
**TE-71-1.0-2.0  
Thermoelectric Module  
(Peltier Module)  
Specifications**

	Material Specifications (27 °C hot side temperature)	Material Specifications (50 °C hot side temperature)
Vmax (V)	8.9	9.9
I <sub>max</sub> (A)	2.3	2.3
Q <sub>max</sub> (W)	12.8	14.0
DT <sub>max</sub> (°C)	70	79
Operation/storage temperature	-40 °C to +80 °C	

Module *material* specifications are nominal values based on the hot-side temperature indicated. Thermoelectric material parameter tolerance is +/-10%.

In no case should the module temperature be allowed to exceed its maximum operation/storage temperature.

Please review all product and technical information, *Thermoelectric Module Mounting Procedure*, FAQ's and ordering information posted on our website before purchasing or using this product.

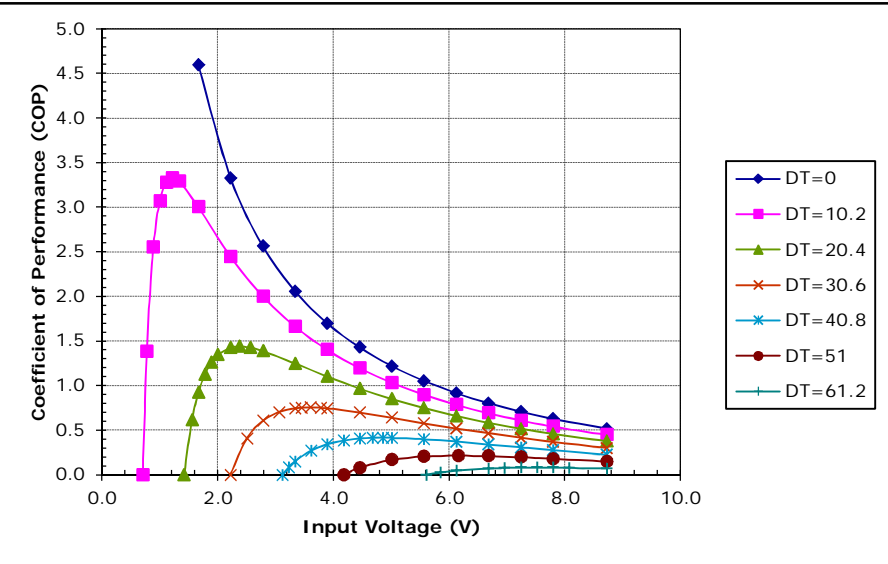
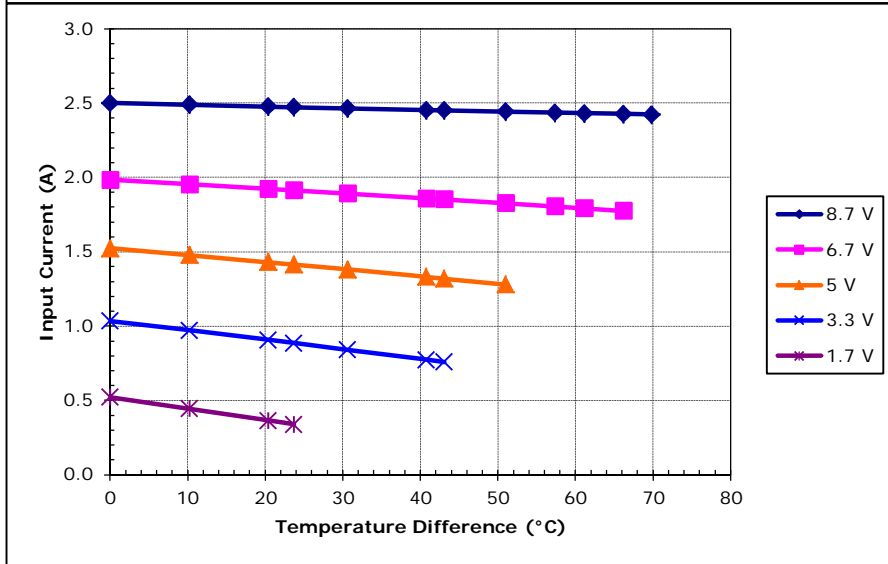
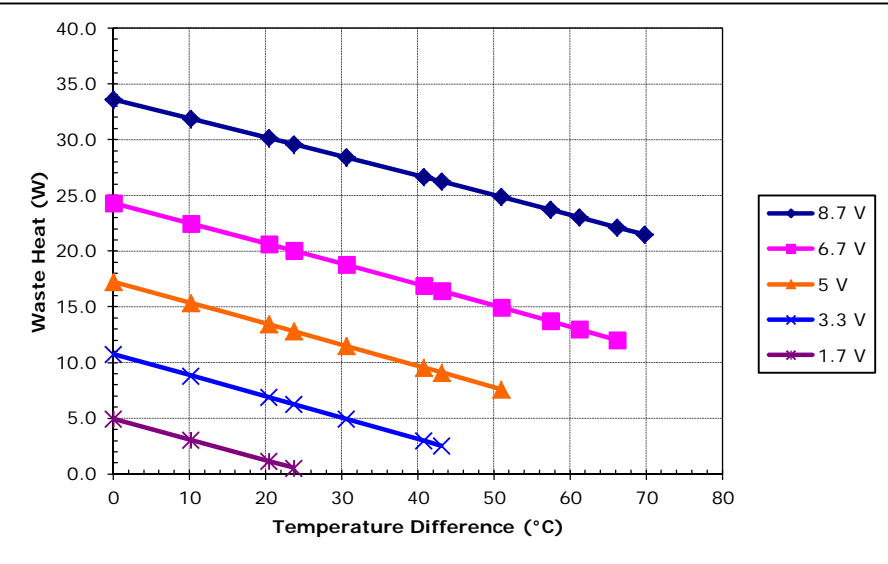
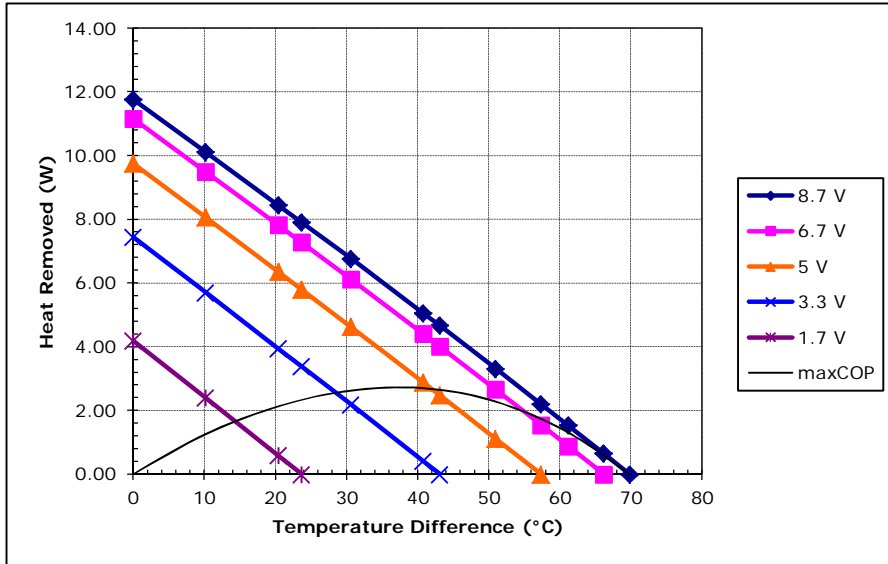


Width, A (mm)	23 +0.5/-0.2
Width, B (mm)	23 +0.5/-0.2
Height, H (mm)	4.3 ±0.05
Flatness, F (mm)	0.02
Parallelism, P (mm)	0.03
Wire Size, WS (mm <sup>2</sup> )	0.2
Wire Length, WL (mm)	120

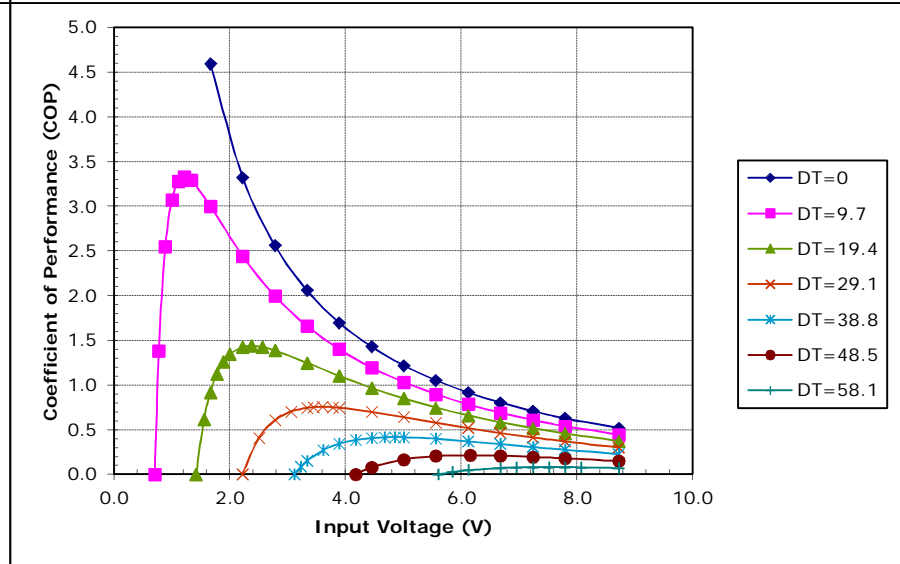
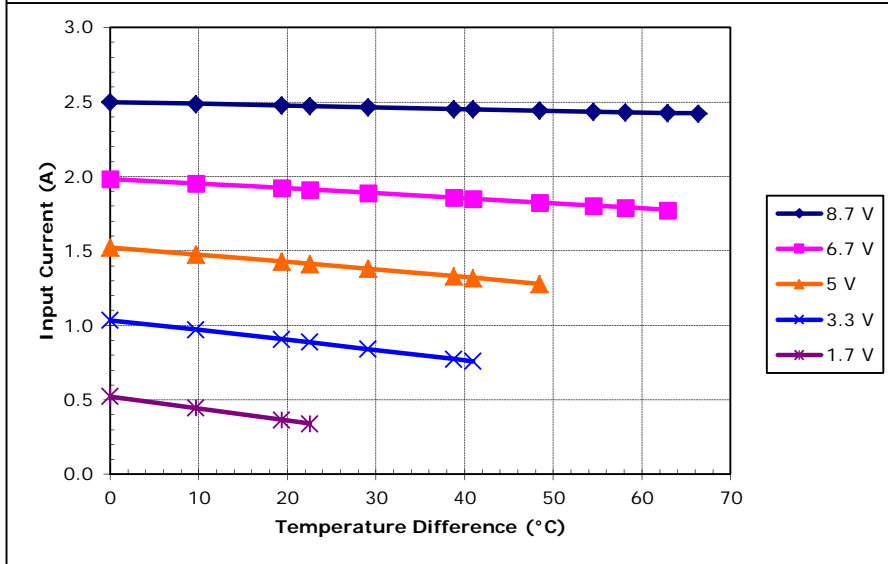
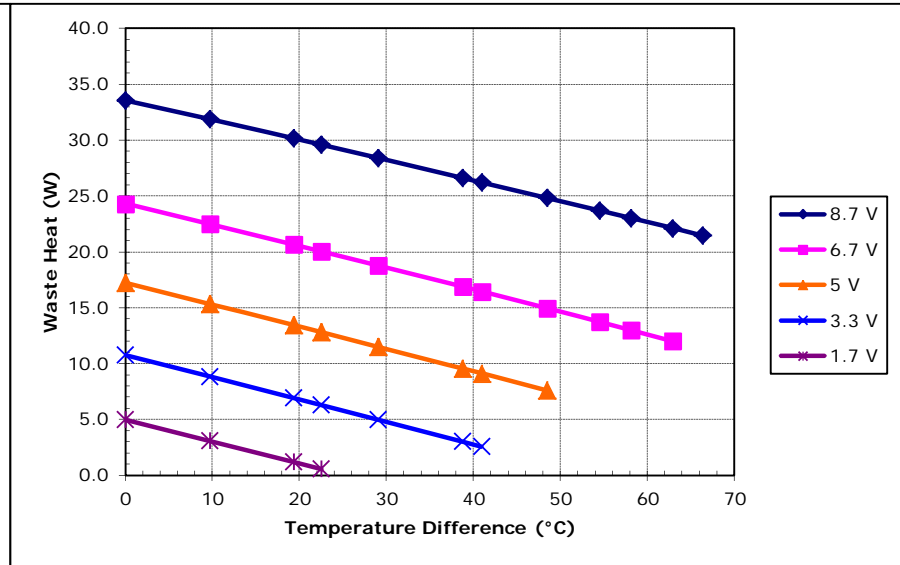
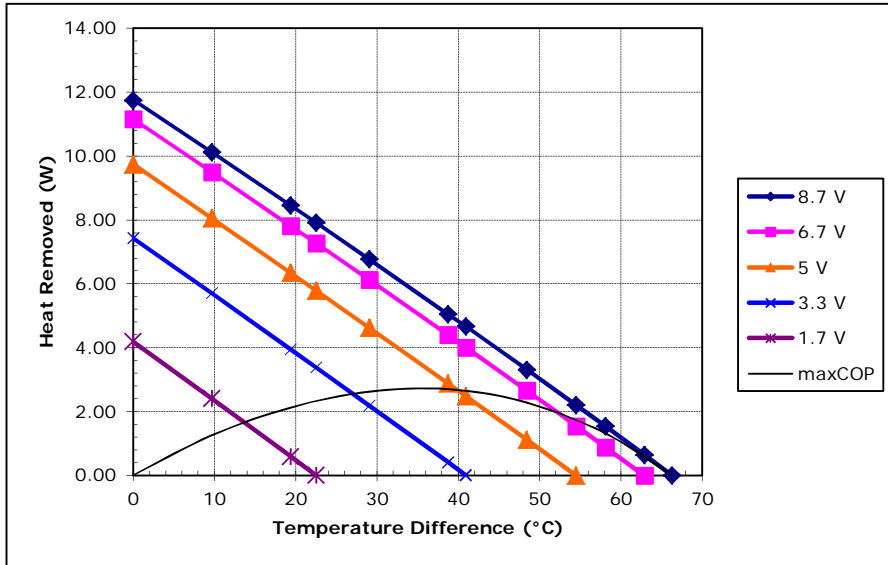
Optional Features and Notes:  
Add "P" to part number for sealing module with epoxy potting.

Performance graphs include thermal resistance of substrates.

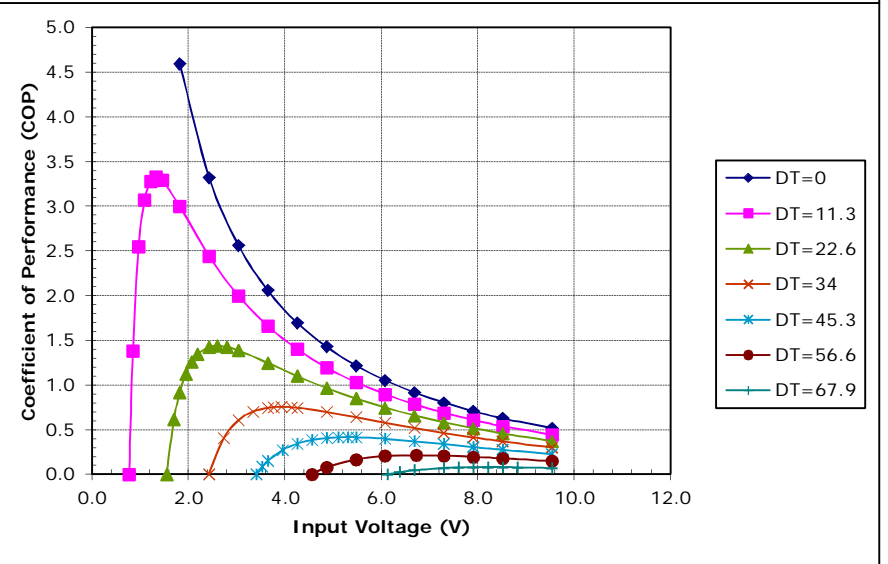
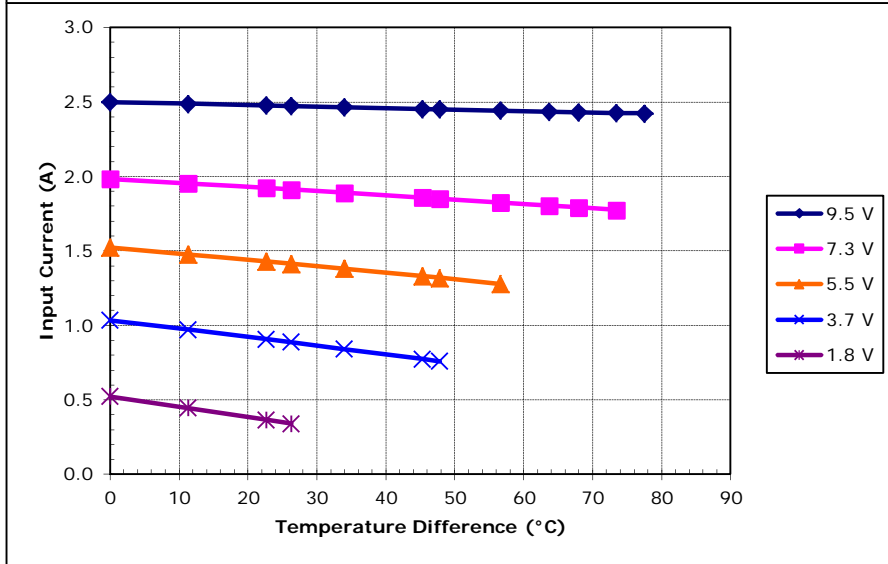
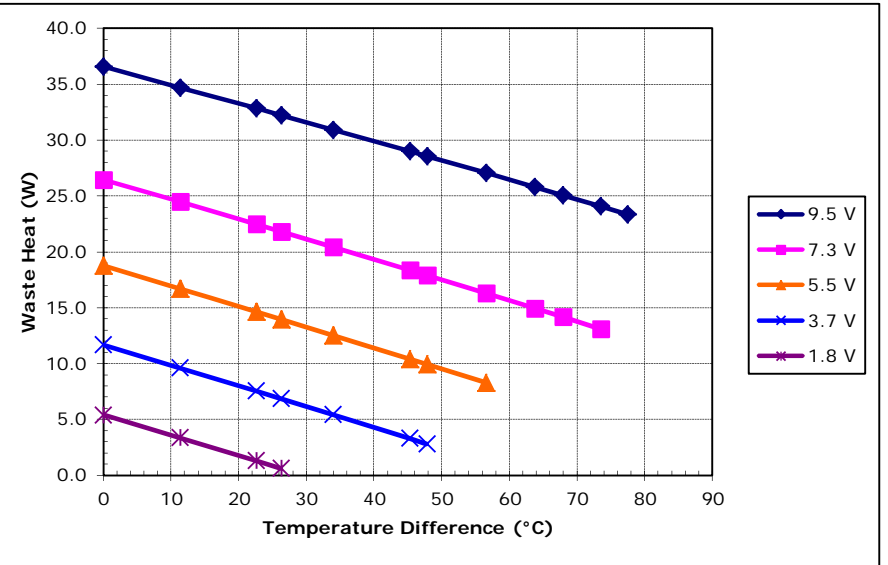
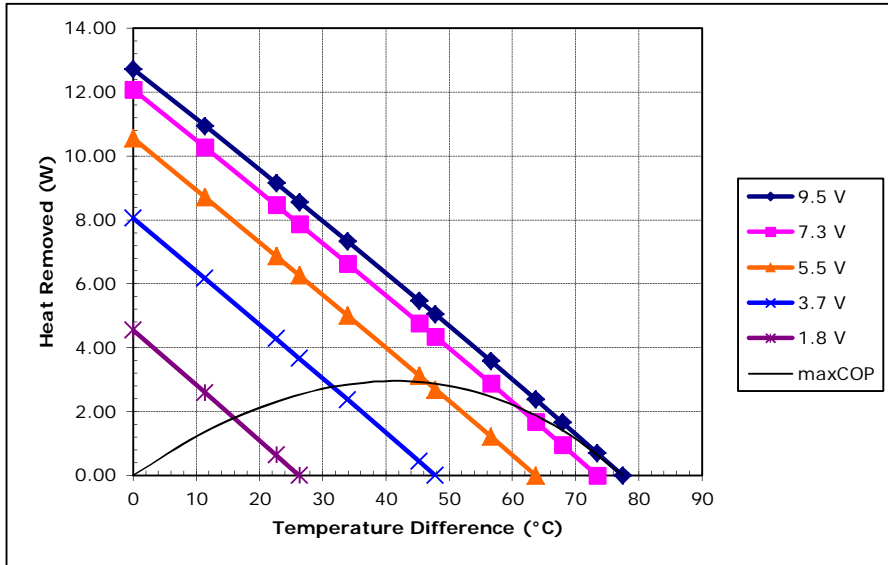
**RoHS Compliant**  
Directive 202/95/EC



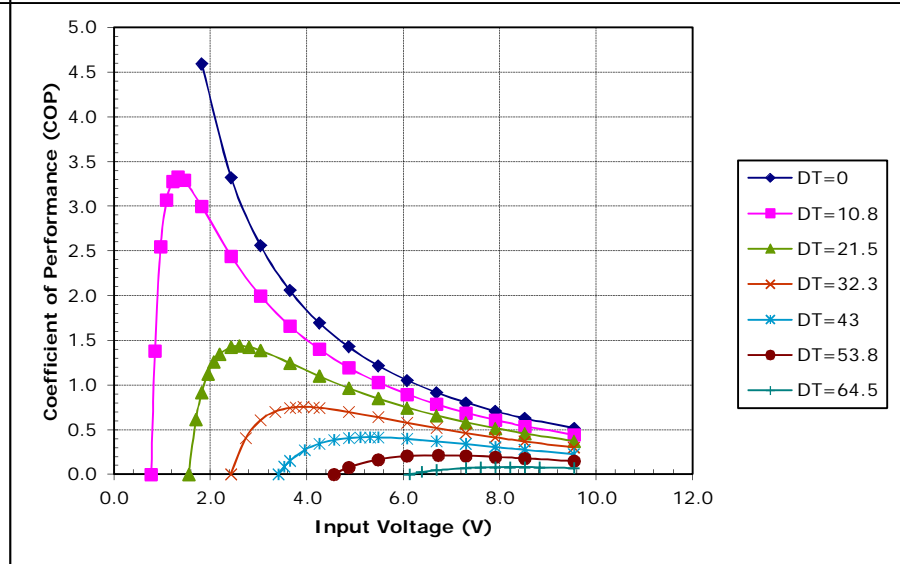
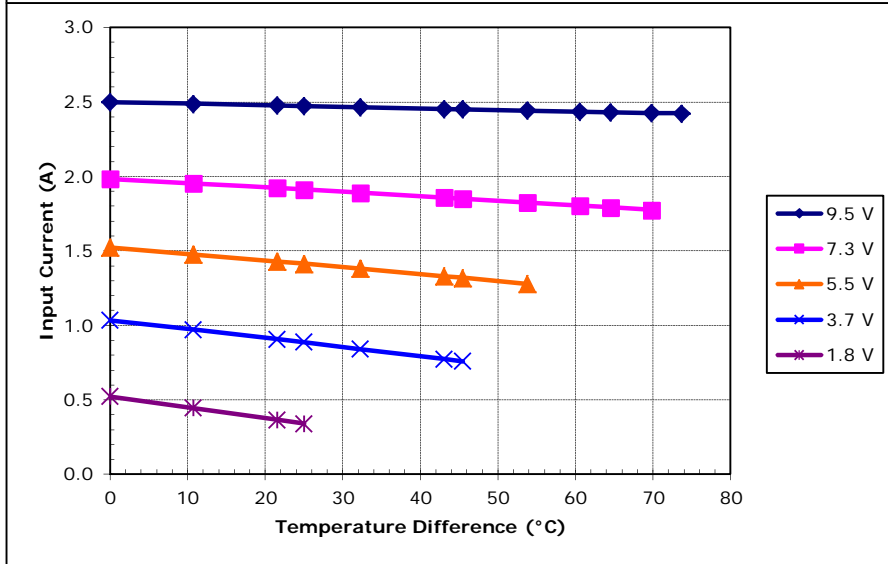
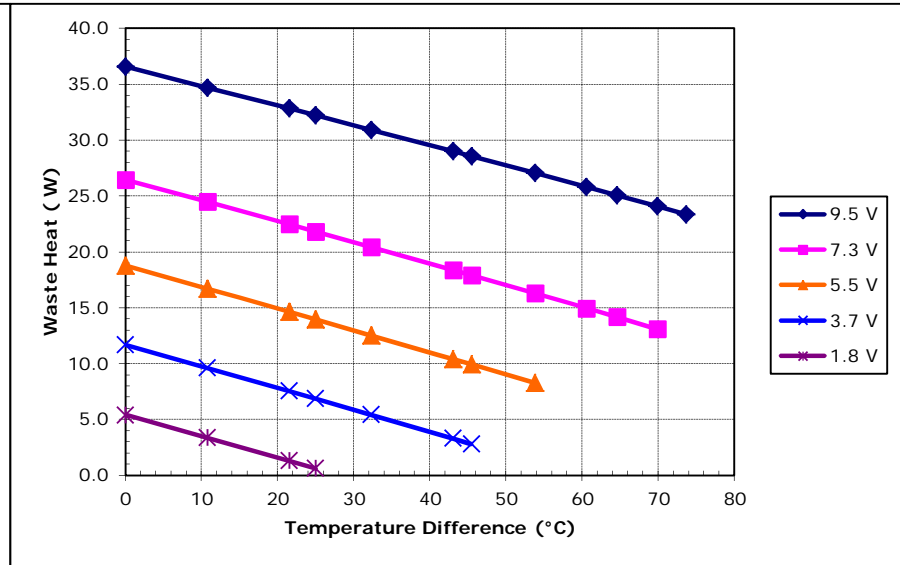
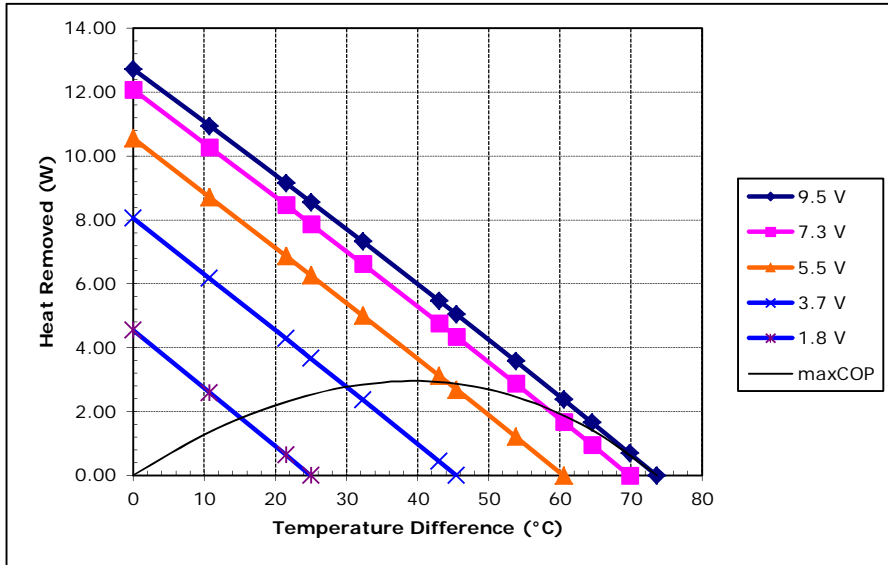
Unpotted TE-71-1.0-2.0 at a hot-side temperature of 30 °C



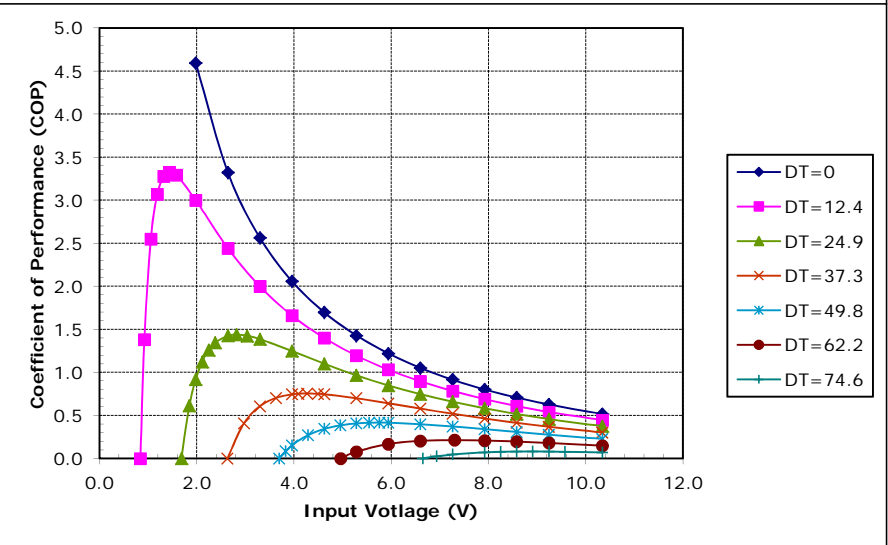
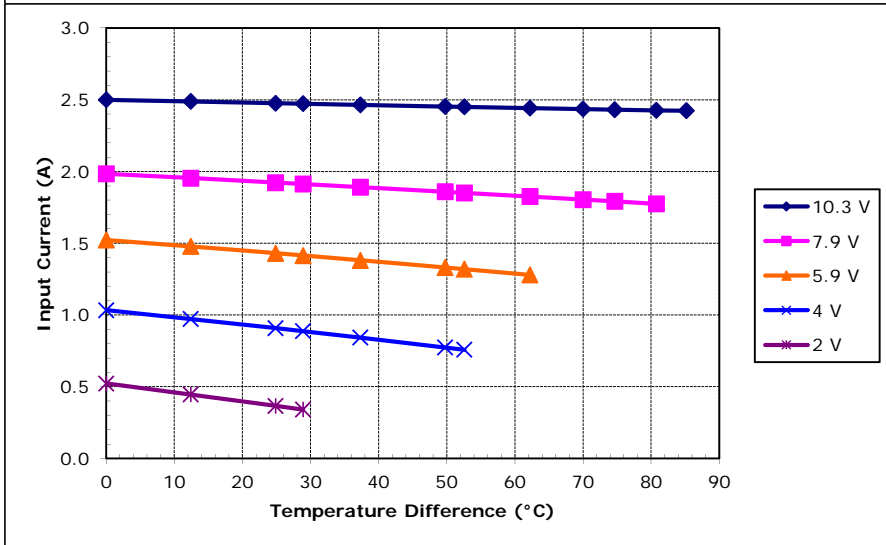
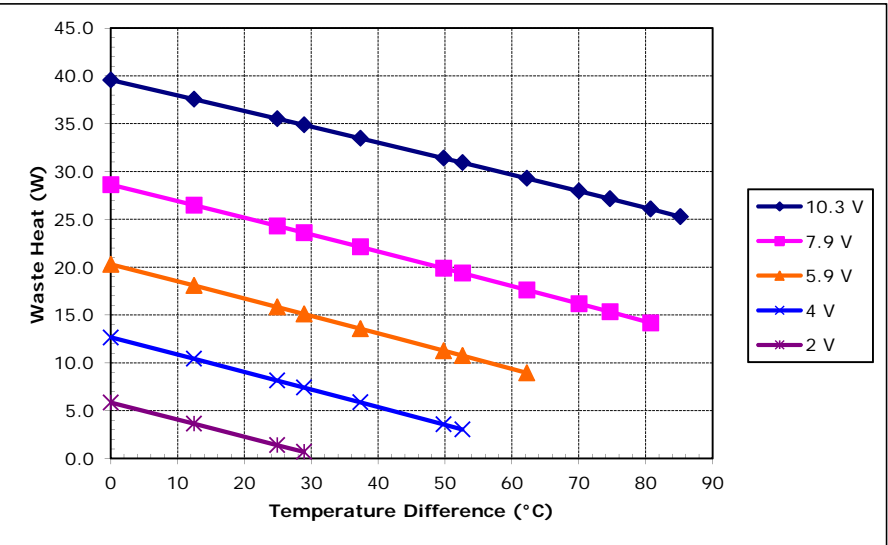
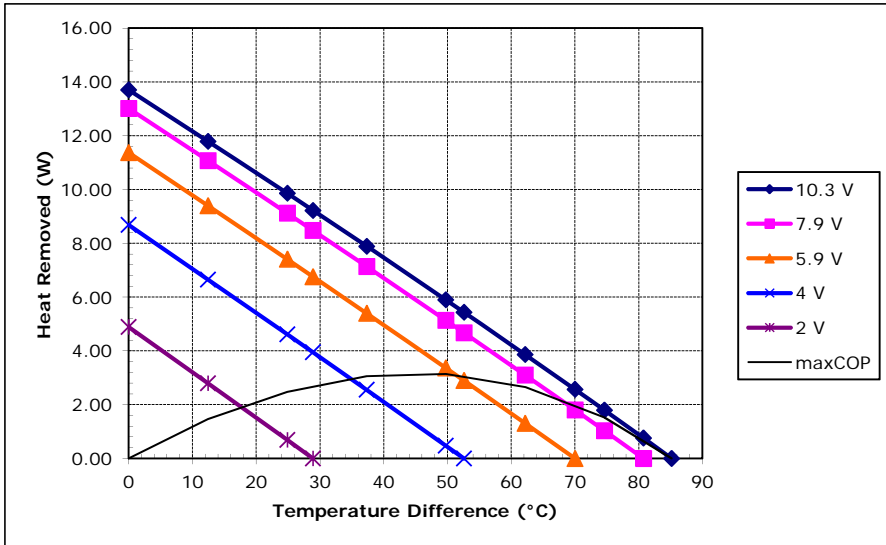
Potted TE-71-1.0-2.0 at a hot-side temperature of 30 °C



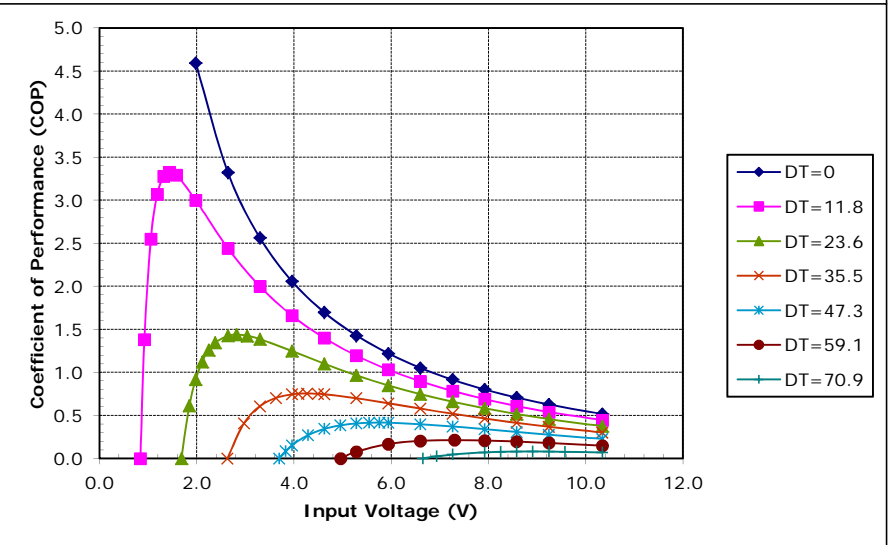
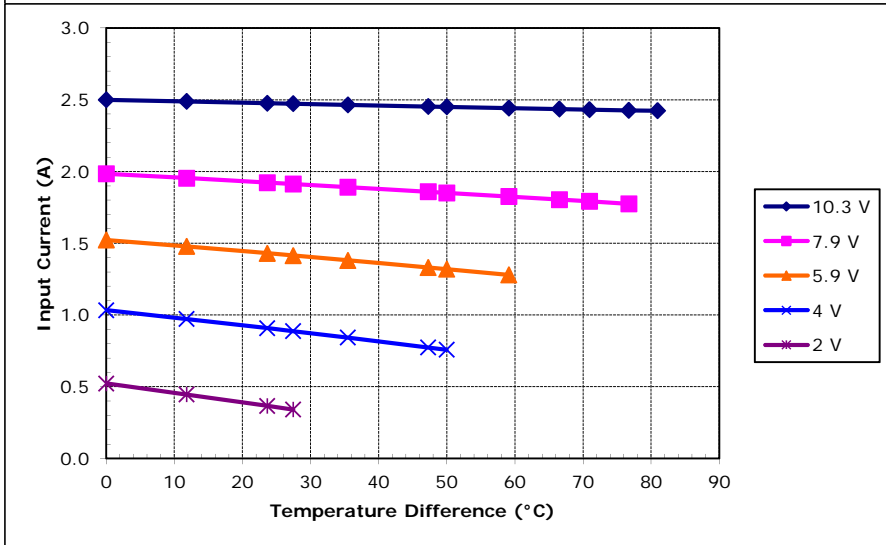
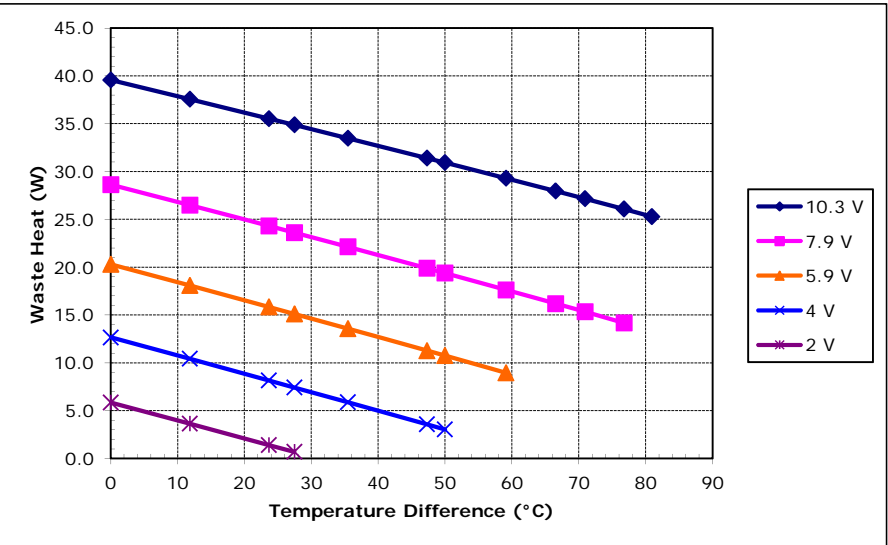
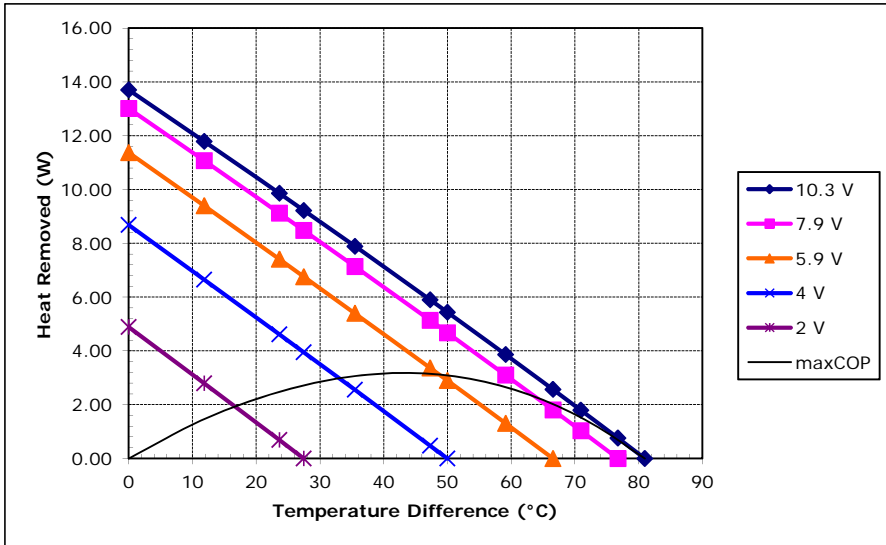
Unpotted TE-71-1.0-2.0 at a hot-side temperature of 50 °C



Potted TE-71-1.0-2.0 at a hot-side temperature of 50 °C



Unpotted TE-71-1.0-2.0 at a hot-side temperature of 70 °C



Potted TE-71-1.0-2.0 at a hot-side temperature of 70 °C